N-Channel Enhancement Mode Power MOSFET

DESCRIPTION

The JTM3400PR uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

GENERAL FEATURES

• VDS = 30 V,ID = 6.8 A

 $R_{DS(ON)} < 59m\Omega @ V_{GS}=2.5V$

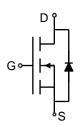
 $R_{DS(ON)} < 45m\Omega$ @ $V_{GS}=4.5$ V

 $R_{DS(ON)} < 41m\Omega @ V_{GS}=10V$

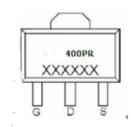
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

Application

- •PWM applications
- •Load switch
- •Power management



Schematic diagram



SOT-89-3L top view

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
JTM3400PR	JTM3400PR	SOT-89-3L	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (TA=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	Vgs	±12	V
Drain Current-Continuous	lo	6.8	A
Drain Current-Pulsed (Note 1)	Ірм	30	А
Maximum Power Dissipation	PD	1.4	W
Operating Junction and Storage Temperature Range	TJ, Tstg	-55 To 150	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	Reja	1.0	°C/W	
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Electrical Characteristics (TA=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	Vgs=0V lp=250µA	30	33	-	V

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Zero Gate Voltage Drain Current	IDSS	VDS=30V, VGS=0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	Vgs=±12V,Vps=0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	Vos=Vgs,lo=250µA	0.7	0.9	1.4	V
		Vgs=2.5V, lp=4A	-	45	59	mΩ
Drain-Source On-State Resistance	RDS(ON)	Vgs=4.5V, lp=2.9A	-	34	45	mΩ
		Vgs=10V, ID=2.9A	-	31	41	mΩ
Forward Transconductance	grs	Vps=5 V,lp=2.9 A	10	-	-	S
Dynamic Characteristics (Note4)				•		
Input Capacitance	Clss	Vps=15V, Vgs=0V,	-	623	-	PF
Output Capacitance	Coss	F=1.0MHz	-	99	-	PF
Reverse Transfer Capacitance	Crss	1 -1.000112	-	77	-	PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	td(on)		-	3.3	-	nS
Turn-on Rise Time	tr	VDD=15V, ID=2.9A	-	4.8	-	nS
Turn-Off Delay Time	td(off)	Vgs=10V,Rgen=3Ω	-	26	-	nS
Turn-Off Fall Time	t _f		-	4	-	nS
Total Gate Charge	Qg	Vps=15V,lp=5.8A,	-	9.5	-	nC
Gate-Source Charge	Qgs	VDS=13V,ID=3.6A, VGS=4.5V	-	1.5	-	nC
Gate-Drain Charge	Qgd	VGS=4.5 V	-	3	-	nC
Drain-Source Diode Characteristics	•		ı		1	
Diode Forward Voltage (Note 3)	VsD	Vgs=0V,ls=2.9A	-	0.75	1.2	V
Diode Forward Current (Note 2)	Is		-	-	2.9	А

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

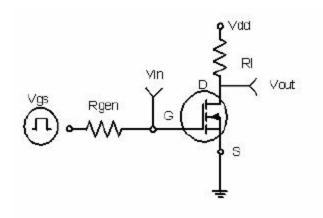


Figure 1:Switching Test Circuit

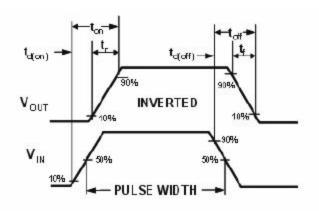
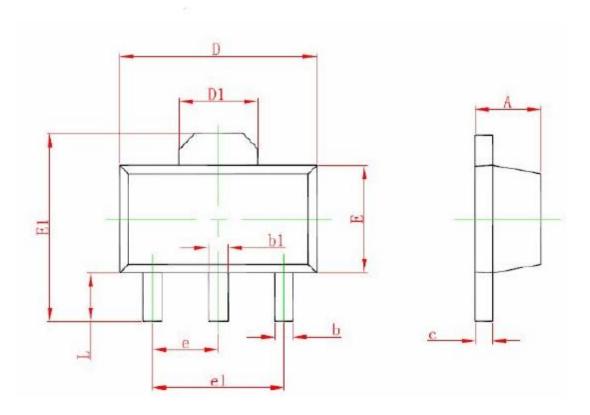


Figure 2: Switching Waveforms

SOT-89-3L PACKAGE INFORMATION



Cl	Dimensions In	n Millimeters	Dimensions	In Inches
Symbol	Min	Max	Min	Max
Α	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
С	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
е	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	O°	8°	0°	8°

NOTES

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- $5. \ \ Controlling \ dimension \ is \ millimeter, \ converted \ inch \ dimensions \ are \ not \ necessarily \ exact.$

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